June1996



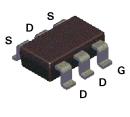
# NDC632P P-Channel Logic Level Enhancement Mode Field Effect Transistor

#### **General Description**

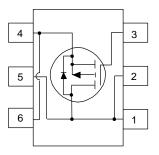
These P-Channel logic level enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to minimize on-state resistance. These devices are particularly suited for low voltage applications such as notebook computer power management and other battery powered circuits where fast high-side switching, and low in-line power loss are needed in a very small outline surface mount package.

## Features

- -2.7A, -20V.  $R_{DS(ON)} = 0.14\Omega$  @  $V_{GS} = -4.5V$  $R_{DS(ON)} = 0.2\Omega$  @  $V_{GS} = -2.7V.$
- Proprietary SuperSOT<sup>TM</sup>-6 package design using copper lead frame for superior thermal and electrical capabilities.
- High density cell design for extremely low R<sub>DS(ON)</sub>.
- Exceptional on-resistance and maximum DC current capability.



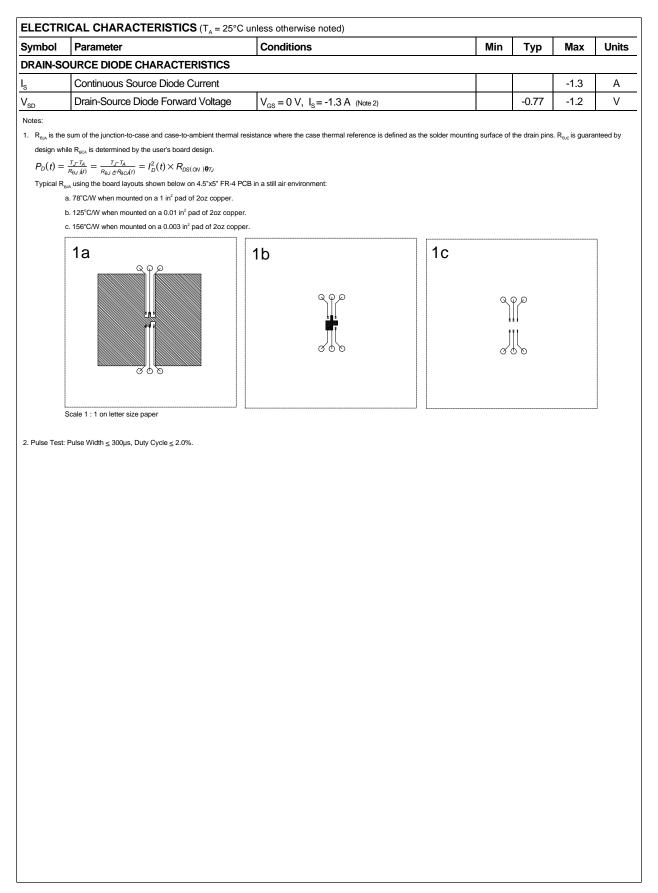
SuperSOT<sup>™</sup>-6

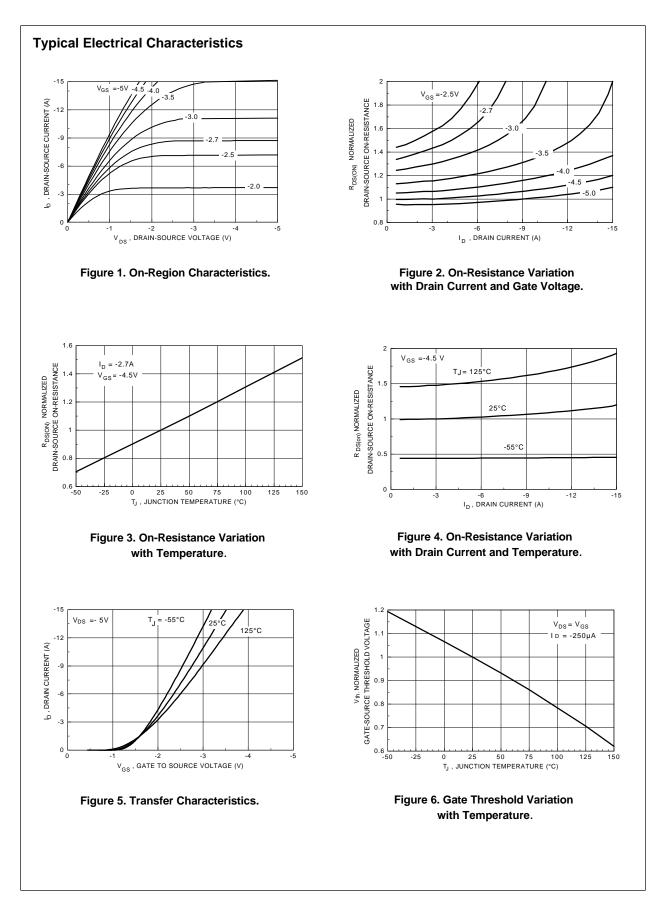


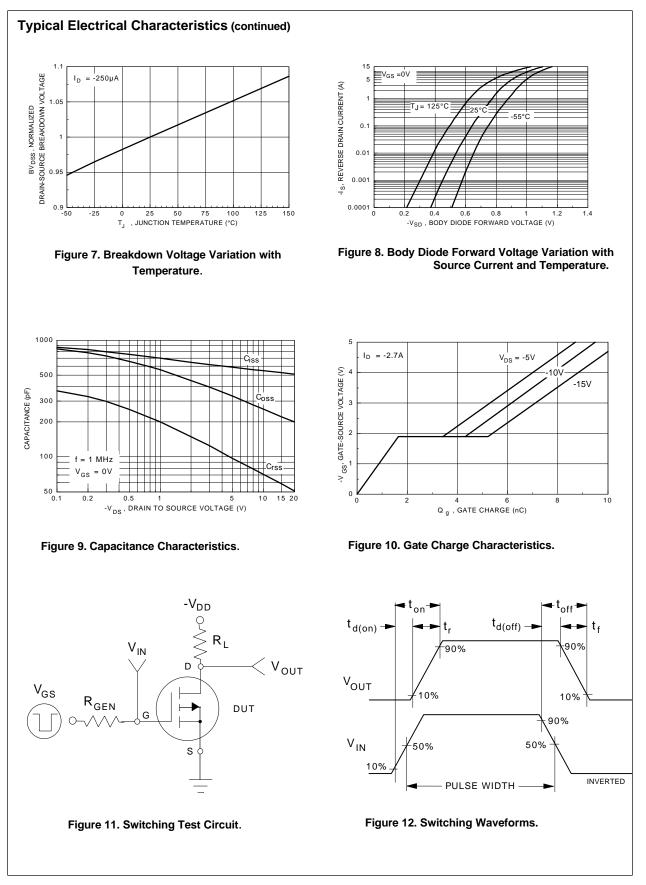
Symbol	Parameter		NDC632P	Units
/ <sub>DSS</sub>	Drain-Source Voltage		-20	V
GSS	Gate-Source Voltage - Continuous		-8	V
)	Drain Current - Continuous		-2.7	A
	- Pulsed		-10	
D D	Maximum Power Dissipation	(Note 1a)	1.6	W
		(Note 1b)	1	
		(Note 1c)	0.8	
J,T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to 150	°C
HERMA	AL CHARACTERISTICS			
θJA	Thermal Resistance, Junction-to-Ambient	(Note 1a)	78	°C/W
θJC	Thermal Resistance, Junction-to-Case	(Note 1)	30	°C/W

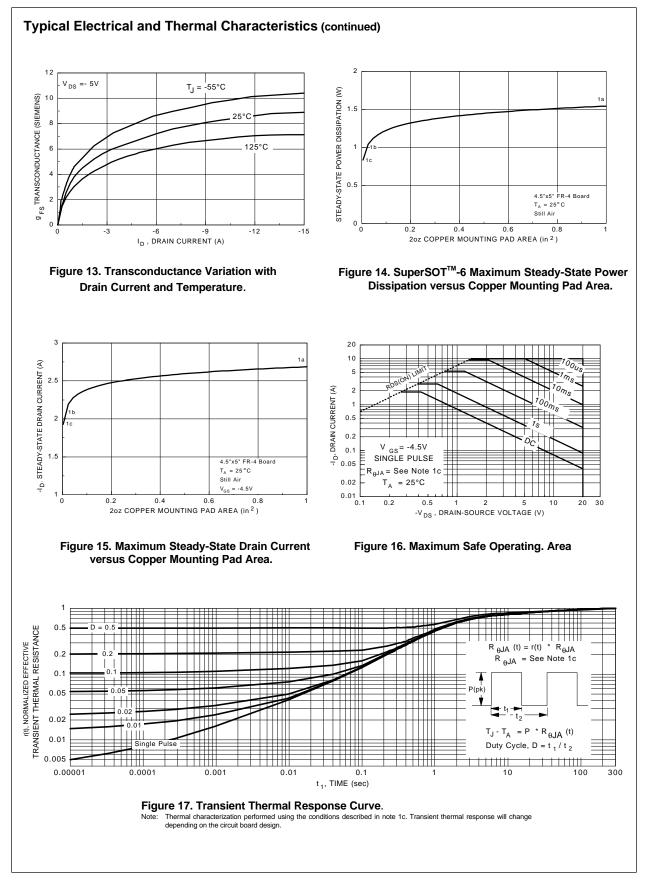
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Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHA	RACTERISTICS						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-20			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = -16 V, V_{GS} = 0 V$				-1	μA
			$T_J = 55^{\circ}C$			-10	μA
I <sub>GSSF</sub>	Gate - Body Leakage, Forward	$V_{GS} = 8 V, V_{DS} = 0 V$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$				-100	nA
ON CHAP	RACTERISTICS (Note 2)						
V <sub>GS(th)</sub>	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = -250 \ \mu A$		-0.4	-0.7	-1	V
			T <sub>J</sub> = 125°C	-0.3	-0.5	-0.8	
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance	$V_{GS} = -4.5 \text{ V}, I_{D} = -2.7 \text{ A}$			0.1	0.14	Ω
			T <sub>J</sub> = 125°C		0.145	0.28	
		$V_{GS} = -2.7 \text{ V}, \ I_{D} = -2.2 \text{ A}$			0.152	0.2	
I <sub>D(on)</sub>	On-State Drain Current	$V_{GS} = -4.5 \text{ V}, V_{DS} = -5 \text{ V}$		-10			A
		$V_{GS} = -2.7 \text{ V}, V_{DS} = -5 \text{ V}$		-4			
<b>g</b> <sub>FS</sub>	Forward Transconductance	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -2.7 \text{ A}$			6		S
DYNAMIC	CHARACTERISTICS						
C <sub>iss</sub>	Input Capacitance	$V_{DS} = -10 V, V_{GS} = 0 V,$			550		pF
C <sub>oss</sub>	Output Capacitance	f = 1.0 MHz			260		pF
C <sub>rss</sub>	Reverse Transfer Capacitance				75		pF
SWITCHI	NG CHARACTERISTICS (Note 2)						
t <sub>D(on)</sub>	Turn - On Delay Time	$V_{DD} = -5 V, I_{D} = -1 A,$			10	20	ns
t,	Turn - On Rise Time	$V_{\text{GEN}}$ = -4.5 V, $R_{\text{GEN}}$ = 6 $\Omega$			40	60	ns
t <sub>D(off)</sub>	Turn - Off Delay Time				25	40	ns
t,	Turn - Off Fall Time				17	30	ns
Q <sub>g</sub>	Total Gate Charge	$V_{DS} = -5 V,$			8.7	15	nC
Q <sub>gs</sub>	Gate-Source Charge	$I_{\rm D} = -2.7 \text{ A}, V_{\rm GS} = -4.5 \text{ V}$			1.7		nC
$Q_{gd}$	Gate-Drain Charge				1.8		nC

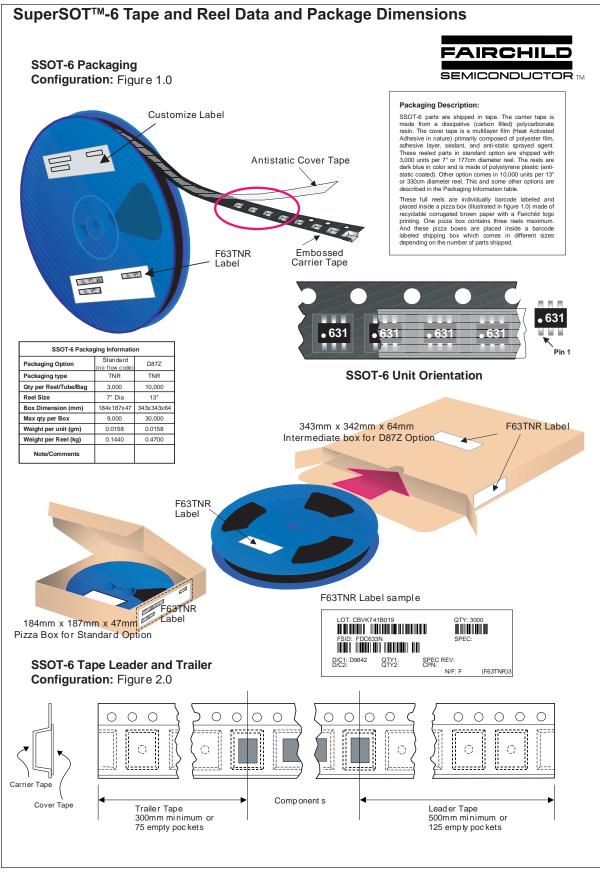




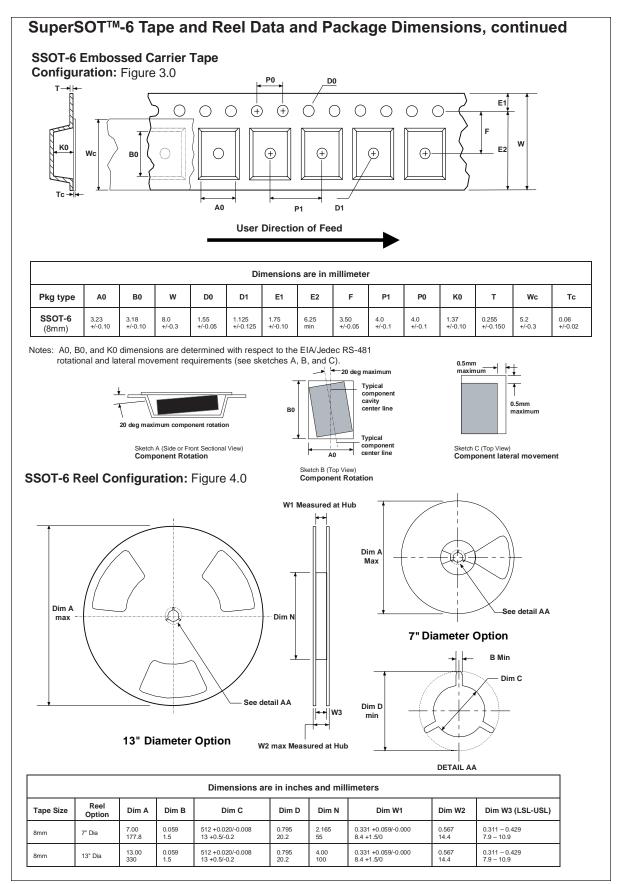




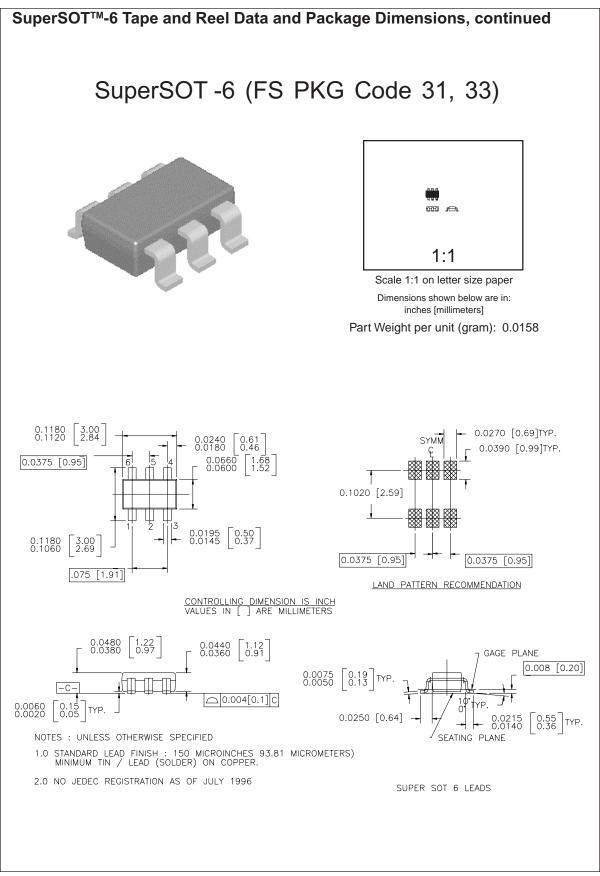
NDC632P Rev. B1



August 1999, Rev. C



July 1999, Rev. C



September 1998, Rev. A

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